



Vincotech

flowBOOST 1 dual	950 V / 100 A
Features <ul style="list-style-type: none">• Dual Booster• High Performance Flying Capacitor Topology• Latest IGBT & SiC Technology• Integrated flying snubber capacitor• Integrated NTC• Low Inductance Design	flow 1 12 mm housing
Target applications <ul style="list-style-type: none">• Solar Inverters	Schematic
Types <ul style="list-style-type: none">• 10-FY10B2A100S7-LP26L06	



Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inner Boost Switch				
Collector-emitter voltage	V_{CES}		950	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	58	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	94	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		150	$^\circ\text{C}$

Outer Boost Switch

Collector-emitter voltage	V_{CES}		950	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	58	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	94	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		150	$^\circ\text{C}$

Inner Boost Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	39	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	141	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10 \text{ ms}$	213	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	105	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Outer Boost Diode				
Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	39	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	141	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10$ ms	213	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	105	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Inner Boost Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	40	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	70	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	75	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Outer Boost Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	40	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	70	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	75	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Flying Capacitor

Maximum DC voltage	V_{MAX}		1000	V
Operation Temperature	T_{op}		0 ... 125	$^\circ\text{C}$



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Maximum Ratings

$T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Capacitor (DC)				
Maximum DC voltage	V_{MAX}		1500	V
Operation Temperature	T_{op}		0 ... 125	$^\circ\text{C}$

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				min. 12,7	mm
Clearance				12,15	mm
Comparative Tracking Index	CTI			≥ 600	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	

Inner Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00167	25	4,35	5,1	5,85	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		100	25 125 150		1,67 1,94 2	2,35 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	950		25			2	μA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							1,5		Ω
Input capacitance	C_{res}	$f = 100 \text{ kHz}$	0	25	25	25	6500	139	20	pF
Output capacitance	C_{oes}									
Reverse transfer capacitance	C_{res}									
Gate charge	Q_g		15		0	25		230		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)						0,74		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	± 15	600	65	25		92,64		
Rise time	t_r					125		94,24		ns
						150		94,72		
Turn-off delay time	$t_{d(off)}$					25		8,32		
						125		9,6		
Fall time	t_f					150		10,24		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD}=0,155 \mu\text{C}$ $Q_{tFWD}=0,181 \mu\text{C}$ $Q_{tFWD}=0,181 \mu\text{C}$				25		115,84		
						125		147,36		
						150		156,64		
Turn-off energy (per pulse)	E_{off}					25		27,5		
						125		54,3		
						150		67,74		ns
						25		0,826		
						125		0,93		
						150		0,956		mWs
						25		1,69		
						125		2,67		
						150		3,01		mWs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	

Outer Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00167	25	4,35	5,1	5,85	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		100	25 125 150		1,67 1,94 2	2,35 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	950		25			2	μA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							1,5		Ω
Input capacitance	C_{res}	$f = 100 \text{ kHz}$	0	25	25	25	6500	139	20	pF
Output capacitance	C_{oes}									
Reverse transfer capacitance	C_{res}									
Gate charge	Q_g		15		0	25		230		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,74		K/W
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Dynamic

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Rise time	t_r					125		94,24		ns
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						125		147,36		
						150		156,64		
Turn-off energy (per pulse)	E_{off}					25		27,5		
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						150		67,74		ns
						25		0,826		
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						150		0,956		mWs
						25		1,69		
						125		2,67		
						150		3,01		mWs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Inner Boost Diode

Static

Forward voltage	V_F				30	25 125 150		1,51 2,03 2,13	1,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V			25		90	750	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,9		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=7063$ A/ μ s $di/dt=6671$ A/ μ s $di/dt=6376$ A/ μ s	± 15	600	65	25 125 150		31,16 30,08 29,75		A
Reverse recovery time	t_{rr}					25 125 150		9,68 10,47 10,5		ns
Recovered charge	Q_r					25 125 150		0,155 0,181 0,181		μ C
Reverse recovered energy	E_{rec}		± 15	600	65	25 125 150		0,063 0,073 0,072		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		9797 7873 7557		A/μ s



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Outer Boost Diode

Static

Forward voltage	V_F				30	25 125 150		1,51 2,03 2,13	1,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V			25		90	750	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,9		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=7063$ A/ μ s $di/dt=6671$ A/ μ s $di/dt=6376$ A/ μ s	± 15	600	65	25 125 150		31,16 30,08 29,75		A
Reverse recovery time	t_{rr}					25 125 150		9,68 10,47 10,5		ns
Recovered charge	Q_r					25 125 150		0,155 0,181 0,181		μ C
Reverse recovered energy	E_{rec}					25 125 150		0,063 0,073 0,072		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		9797 7873 7557		A/μ s



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	

Inner Boost Sw. Protection Diode

Static

Forward voltage	V_F				35	25 125 150		1,66 1,76 1,74	2,1 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V				25			40	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,27		K/W
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Outer Boost Sw. Protection Diode

Static

Forward voltage	V_F				35	25 125 150		1,66 1,76 1,74	2,1 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V				25			40	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,27		K/W
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Flying Capacitor

Static

Capacitance	C	DC bias voltage = 0 V				25		47		nF
Tolerance							-10		10	%



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max

Capacitor (DC)

Static

Capacitance	C	DC bias voltage = 0 V				25		33		nF
Tolerance							-10		10	%
Dissipation factor		$f = 1$ kHz				25		2,5		%

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P							5		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

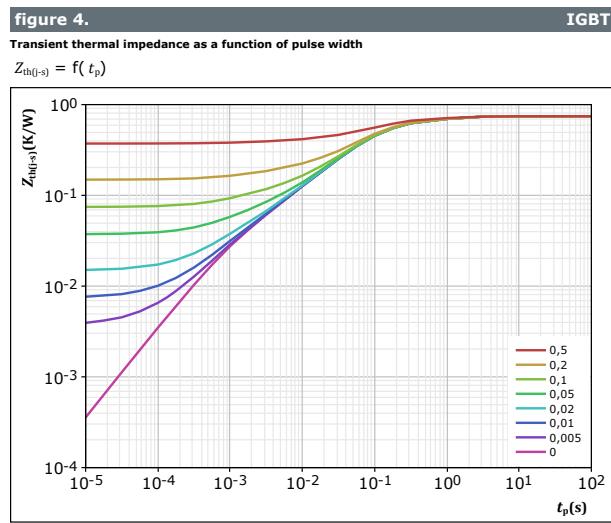
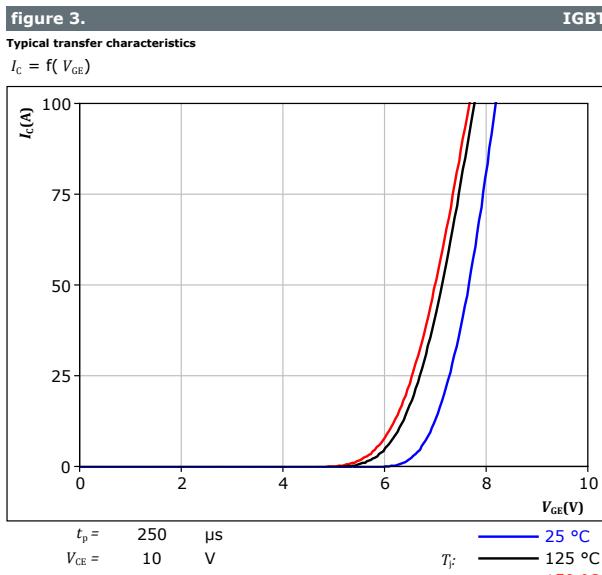
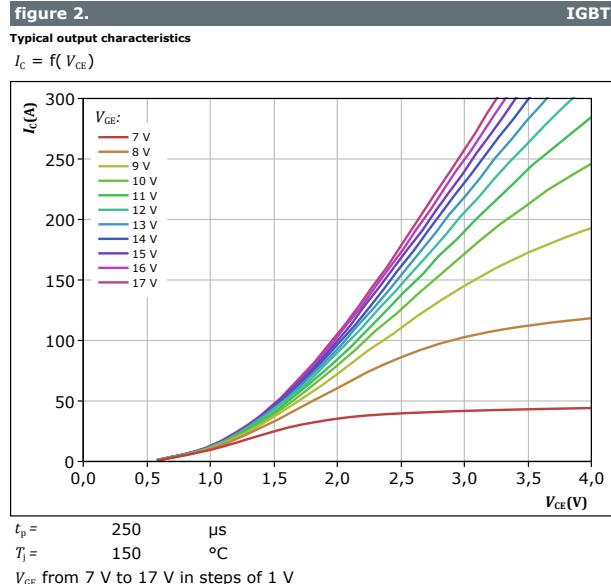
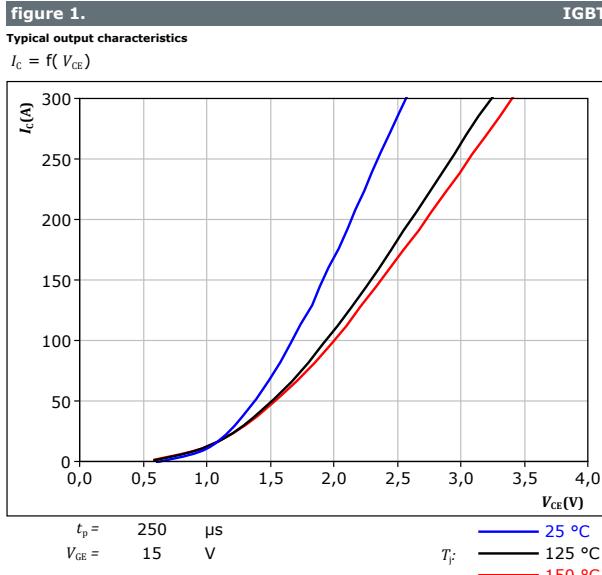
(1) Value at chip level

(2) Only valid with pre-applied Vincotech thermal interface material.



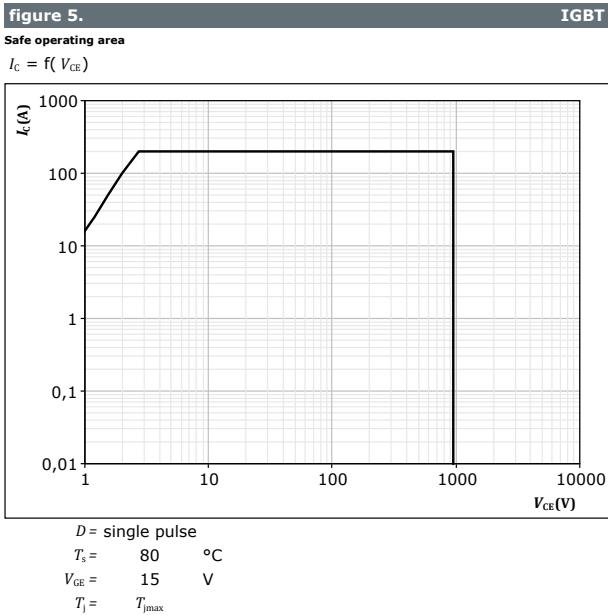
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Inner Boost Switch Characteristics





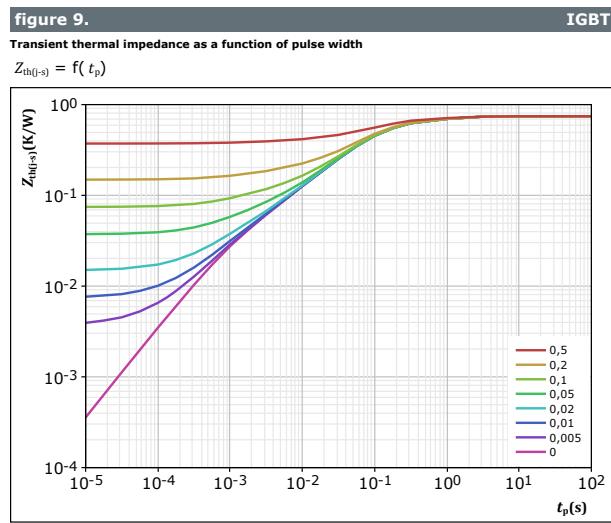
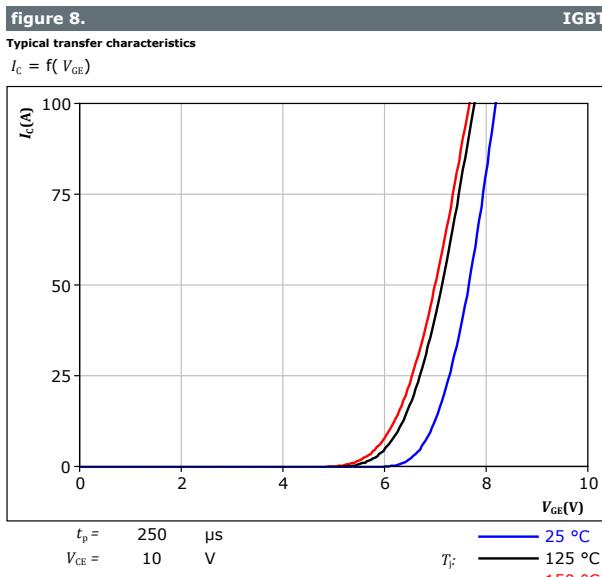
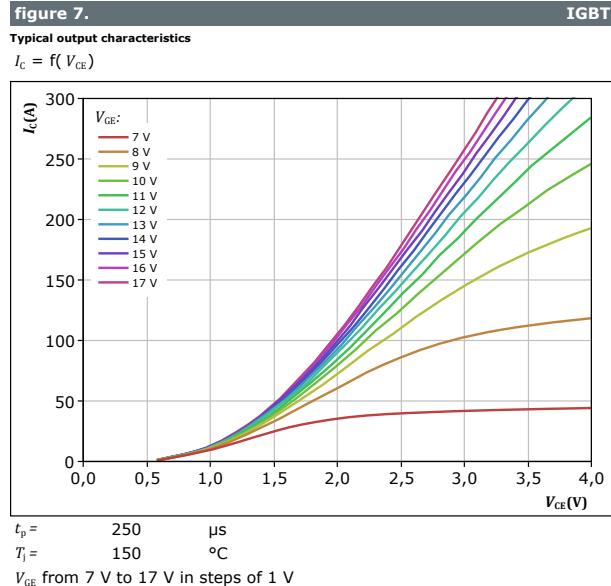
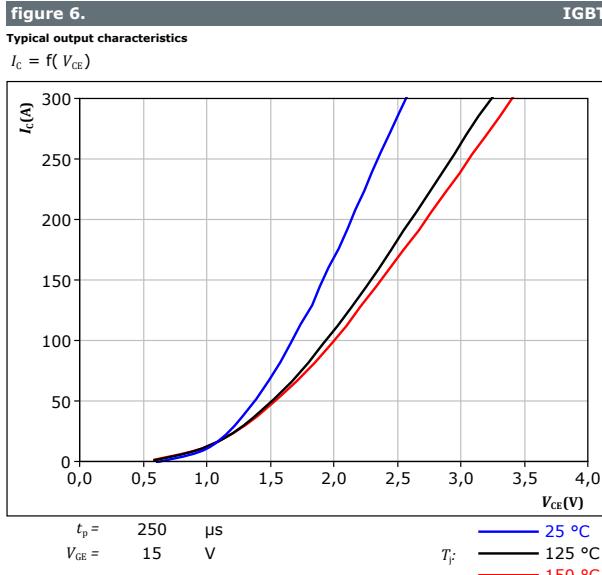
Inner Boost Switch Characteristics





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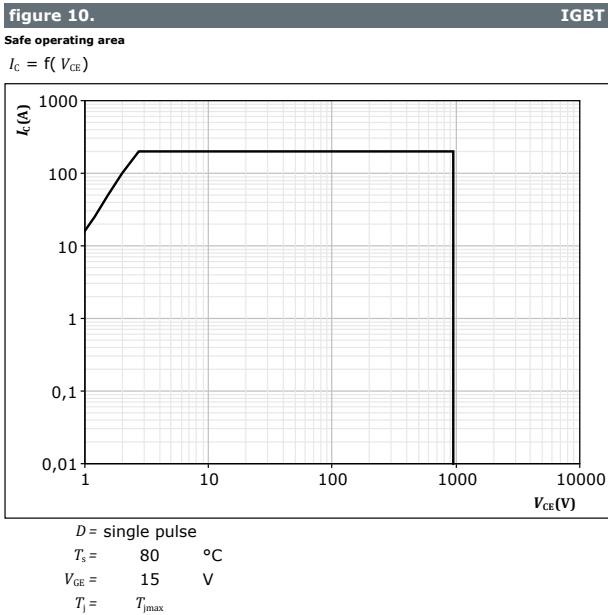
Outer Boost Switch Characteristics



IGBT thermal model values		
R (K/W)	τ (s)	
1,10E-01	1,21E+00	
2,70E-01	1,55E-01	
2,88E-01	5,60E-02	
5,30E-02	8,10E-03	
2,36E-02	1,06E-03	



Outer Boost Switch Characteristics

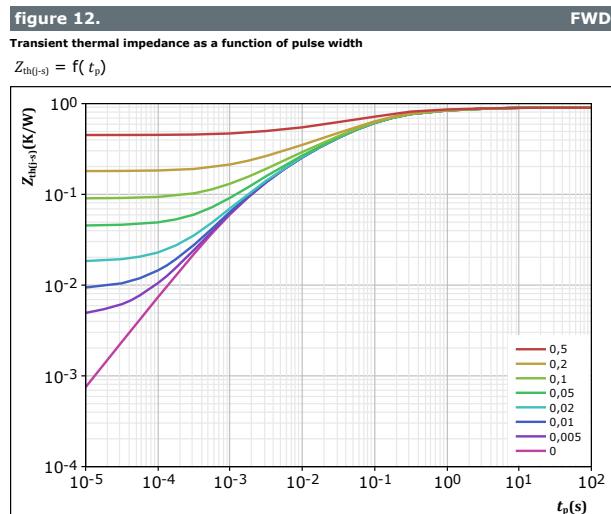
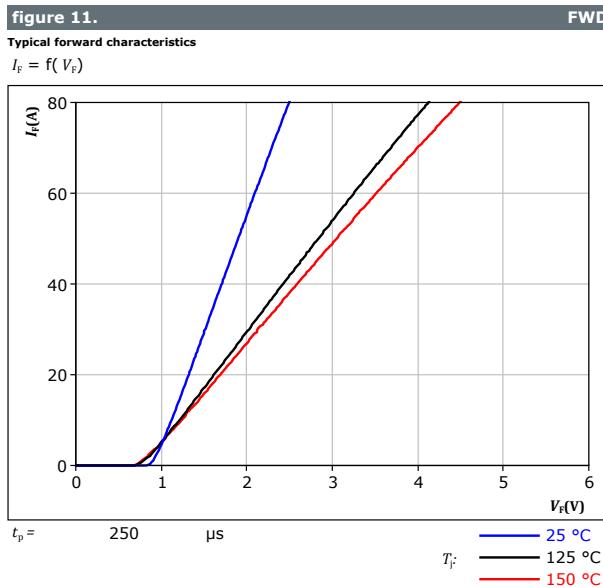




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Inner Boost Diode Characteristics





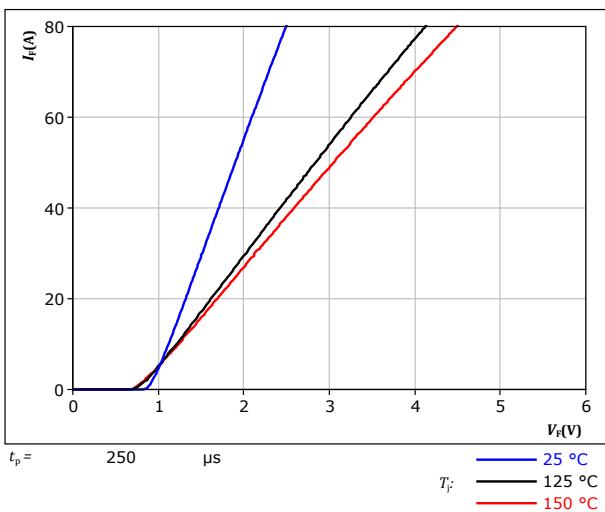
Outer Boost Diode Characteristics

figure 13.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

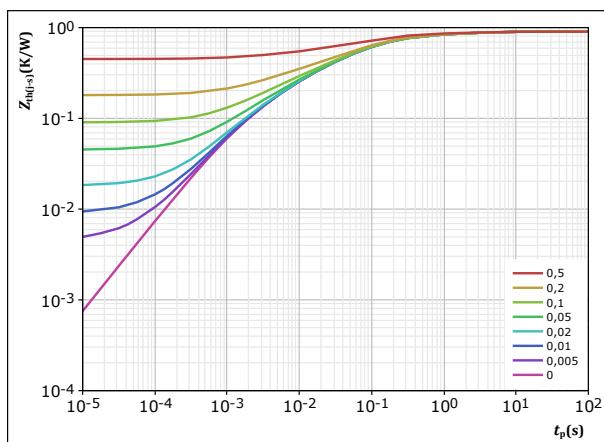
T_F :
— 25 °C
— 125 °C
— 150 °C

figure 14.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p}{T}$$

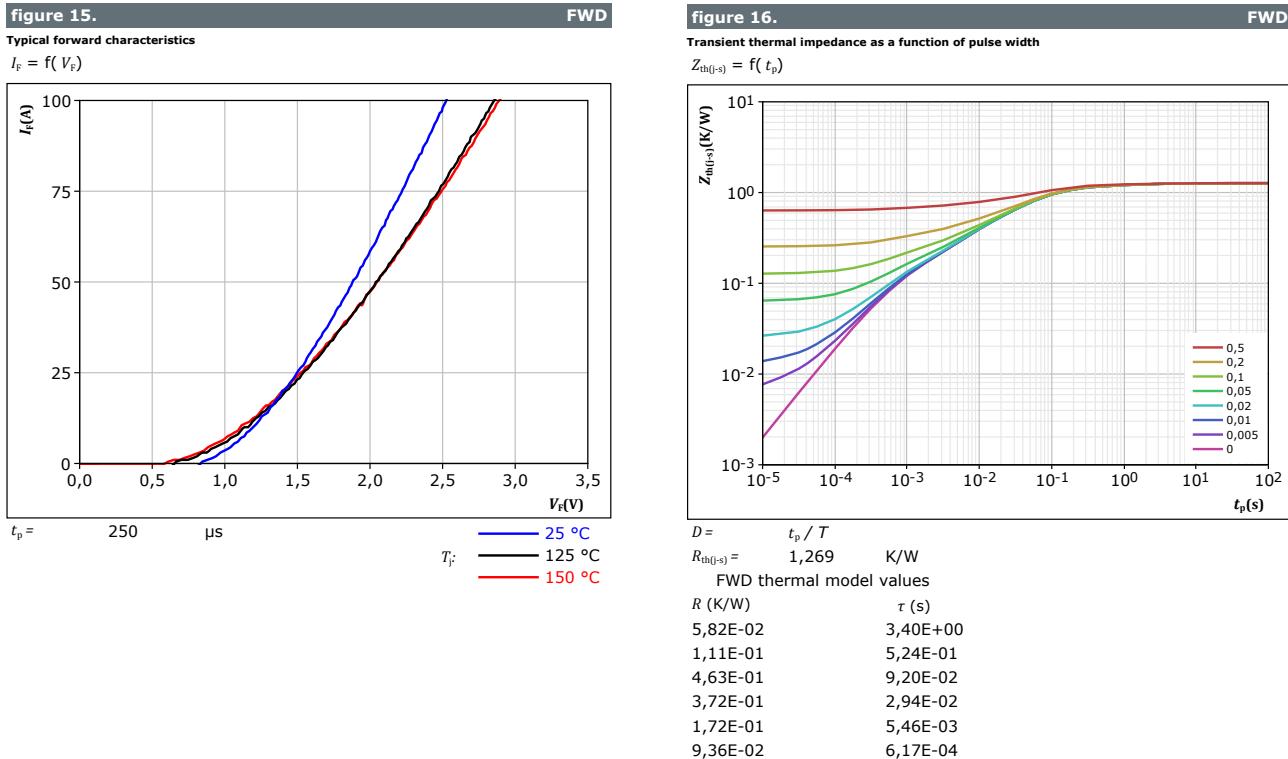
$$R_{th(j-s)} = 0,901 \text{ K/W}$$

FWD thermal model values

$R(K/W)$	$\tau(s)$
6,65E-02	3,02E+00
1,53E-01	3,98E-01
4,06E-01	7,42E-02
2,08E-01	9,81E-03
6,71E-02	1,40E-03



Inner Boost Sw. Protection Diode Characteristics





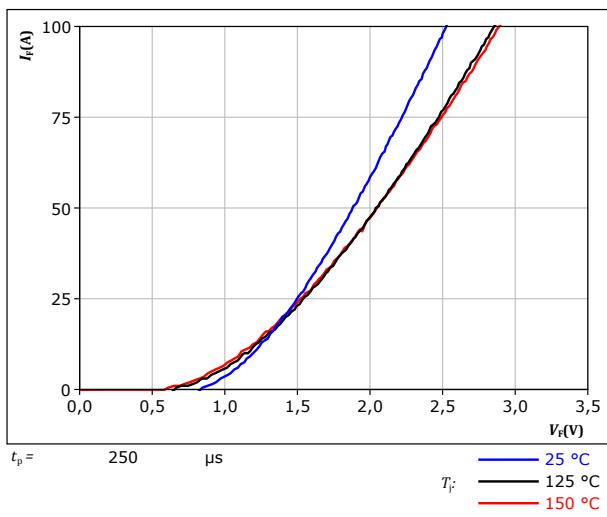
Outer Boost Sw. Protection Diode Characteristics

figure 17.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

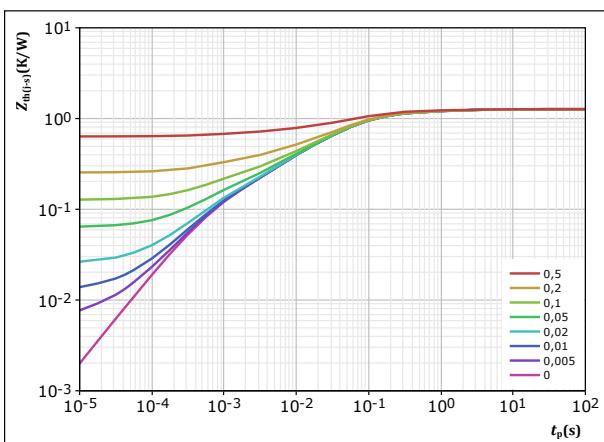
T_F :
— 25 °C
— 125 °C
— 150 °C

figure 18.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



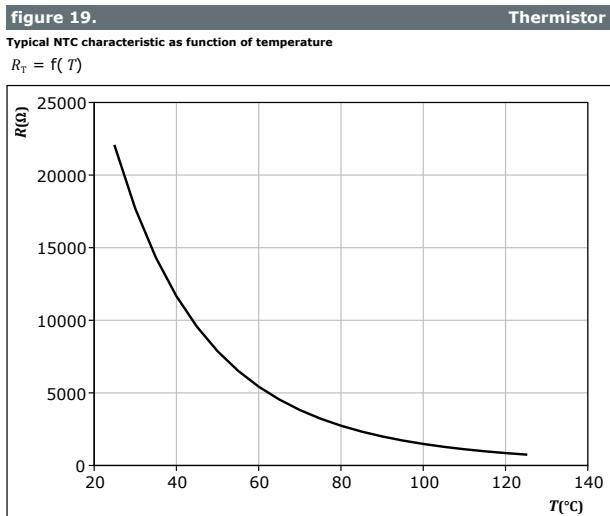
$$D = \frac{t_p}{T} \quad R_{th(j-s)} = \frac{t_p}{1,269} \quad K/W$$

FWD thermal model values

R (K/W)	τ (s)
5,82E-02	3,40E+00
1,11E-01	5,24E-01
4,63E-01	9,20E-02
3,72E-01	2,94E-02
1,72E-01	5,46E-03
9,36E-02	6,17E-04



Thermistor Characteristics





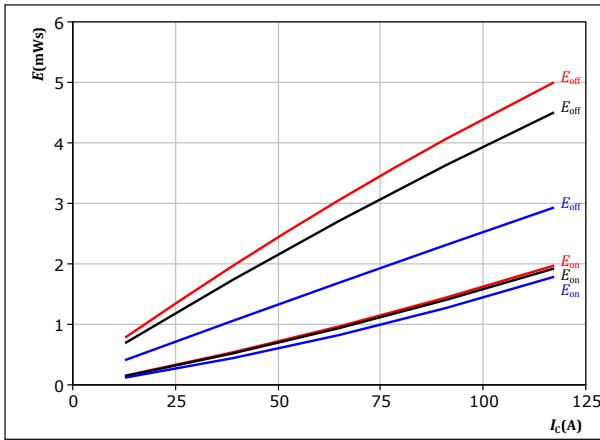
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Inner Boost Switching Characteristics

figure 20.

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

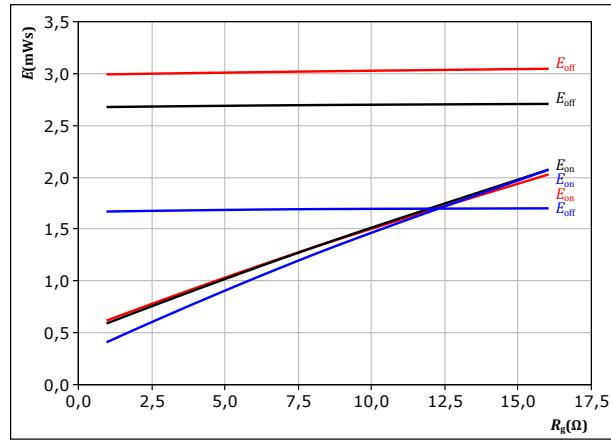
$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 4 \Omega \\ R_{goff} &= 4 \Omega \end{aligned}$$

IGBT

figure 21.

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

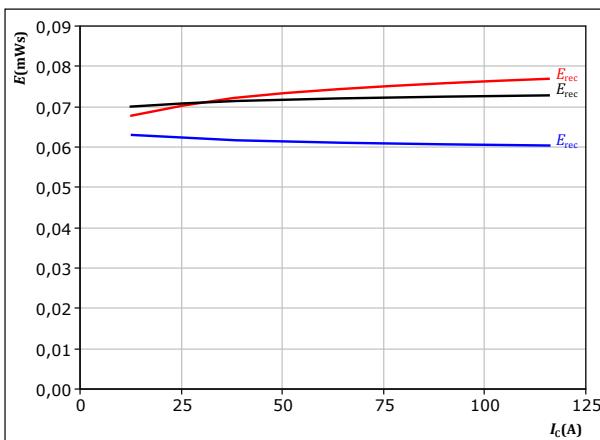
$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ I_c &= 65 \text{ A} \end{aligned}$$

IGBT

figure 22.

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

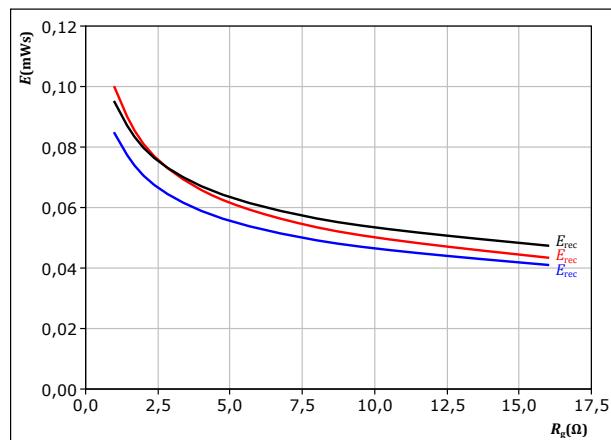
$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 4 \Omega \end{aligned}$$

FWD

figure 23.

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ I_c &= 65 \text{ A} \end{aligned}$$

FWD

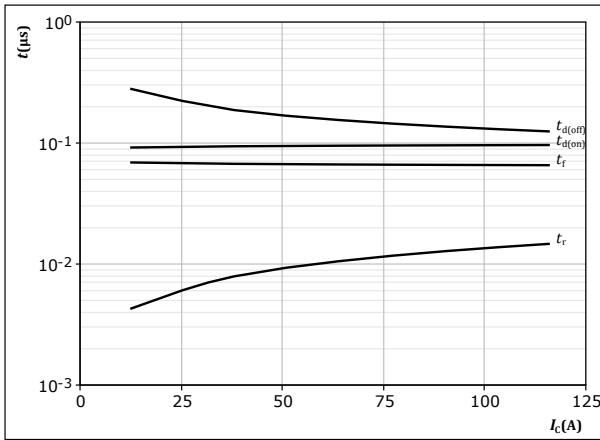


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Inner Boost Switching Characteristics

figure 24. IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$

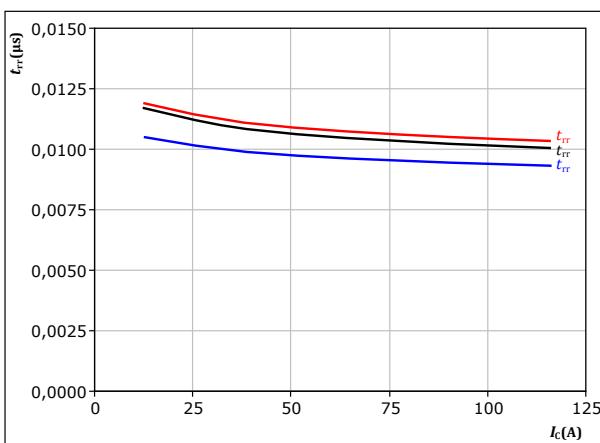


With an inductive load at

T_j = 150 °C
V_{CE} = 600 V
V_{GE} = ±15 V
R_{gon} = 4 Ω
R_{goff} = 4 Ω

figure 26. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



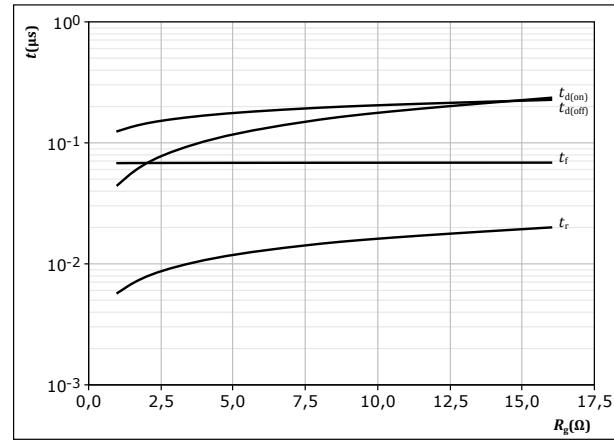
With an inductive load at

V_{CE} = 600 V
V_{GE} = ±15 V
R_{gon} = 4 Ω

T_j: 25 °C
125 °C
150 °C

figure 25. IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$

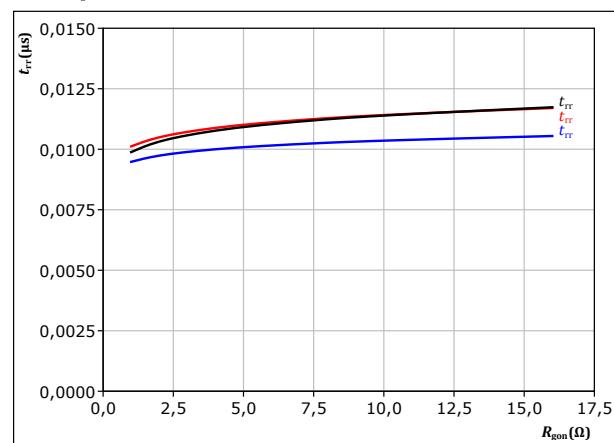


With an inductive load at

T_j = 150 °C
V_{CE} = 600 V
V_{GE} = ±15 V
I_C = 65 A

figure 27. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

V_{CE} = 600 V
V_{GE} = ±15 V
I_C = 65 A

T_j: 25 °C
125 °C
150 °C



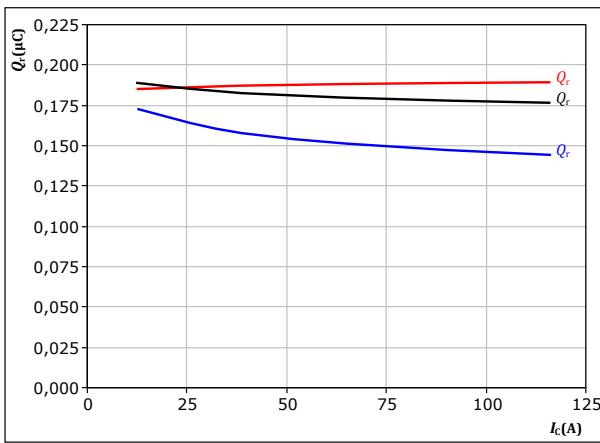
Vincotech

Inner Boost Switching Characteristics

figure 28.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

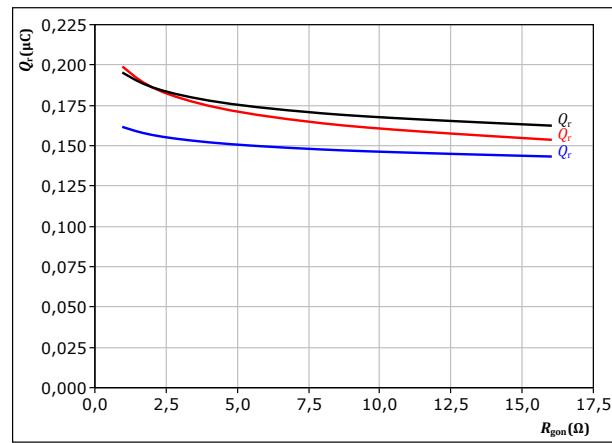
$$\begin{aligned} V_{CE} &= 600 \quad V \\ V_{GE} &= \pm 15 \quad V \\ R_{gon} &= 4 \quad \Omega \end{aligned} \quad T_f: \begin{array}{ll} \text{---} & 25 \text{ }^{\circ}\text{C} \\ \text{---} & 125 \text{ }^{\circ}\text{C} \\ \text{---} & 150 \text{ }^{\circ}\text{C} \end{array}$$

FWD

figure 29.

Typical recovered charge as a function of turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

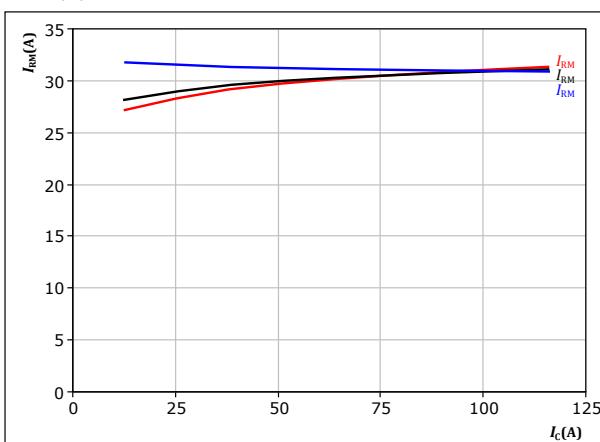
$$\begin{aligned} V_{CE} &= 600 \quad V \\ V_{GE} &= \pm 15 \quad V \\ I_c &= 65 \quad A \end{aligned} \quad T_f: \begin{array}{ll} \text{---} & 25 \text{ }^{\circ}\text{C} \\ \text{---} & 125 \text{ }^{\circ}\text{C} \\ \text{---} & 150 \text{ }^{\circ}\text{C} \end{array}$$

FWD

figure 30.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

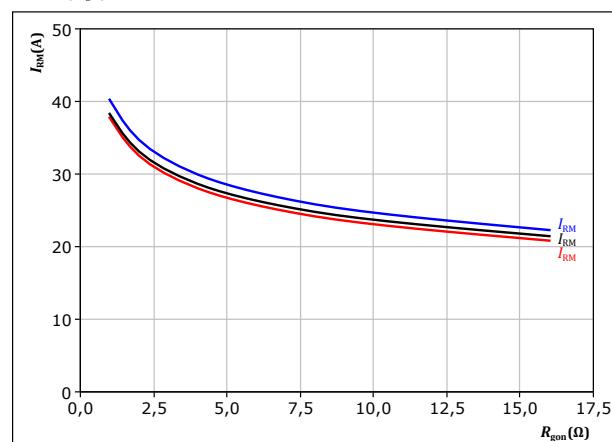
$$\begin{aligned} V_{CE} &= 600 \quad V \\ V_{GE} &= \pm 15 \quad V \\ R_{gon} &= 4 \quad \Omega \end{aligned} \quad T_f: \begin{array}{ll} \text{---} & 25 \text{ }^{\circ}\text{C} \\ \text{---} & 125 \text{ }^{\circ}\text{C} \\ \text{---} & 150 \text{ }^{\circ}\text{C} \end{array}$$

FWD

figure 31.

Typical peak reverse recovery current as a function of turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad V \\ V_{GE} &= \pm 15 \quad V \\ I_c &= 65 \quad A \end{aligned} \quad T_f: \begin{array}{ll} \text{---} & 25 \text{ }^{\circ}\text{C} \\ \text{---} & 125 \text{ }^{\circ}\text{C} \\ \text{---} & 150 \text{ }^{\circ}\text{C} \end{array}$$

FWD

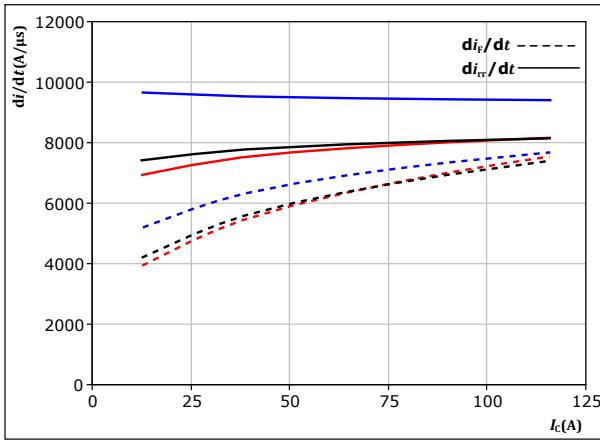


Vincotech

Inner Boost Switching Characteristics

figure 32. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$

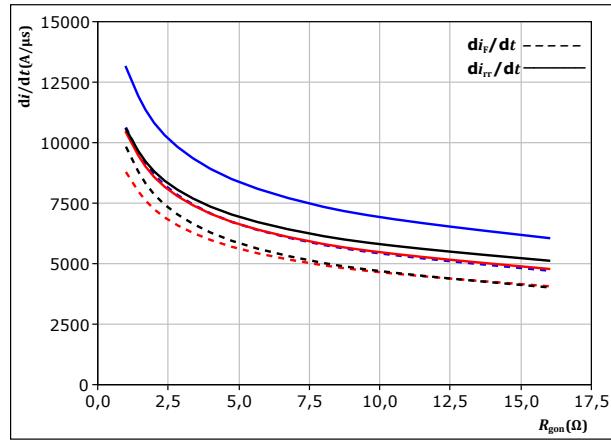


With an inductive load at

$V_{CE} = 600$ V $T_j = 25, 125, 150$ °C
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

figure 33. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$

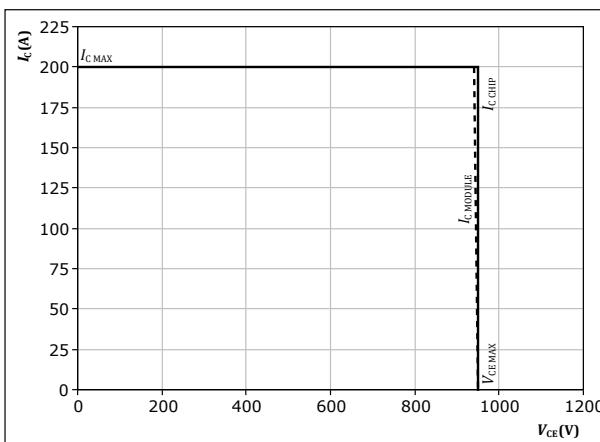


With an inductive load at
 $V_{CE} = 600$ V $T_j = 25, 125, 150$ °C
 $V_{GE} = \pm 15$ V
 $I_c = 65$ A

figure 34. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

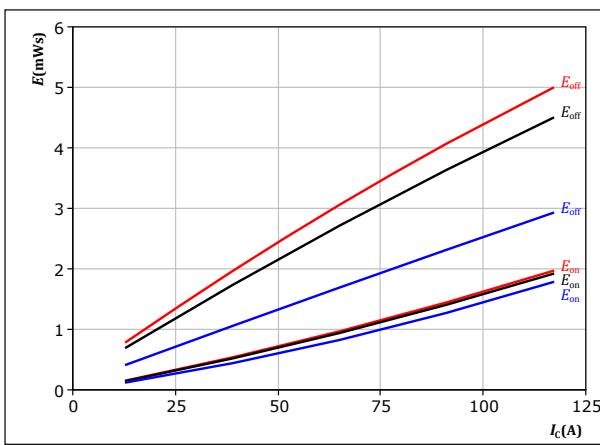


Vincotech

Outer Boost Switching Characteristics

figure 35.

Typical switching energy losses as a function of collector current
 $E = f(I_c)$



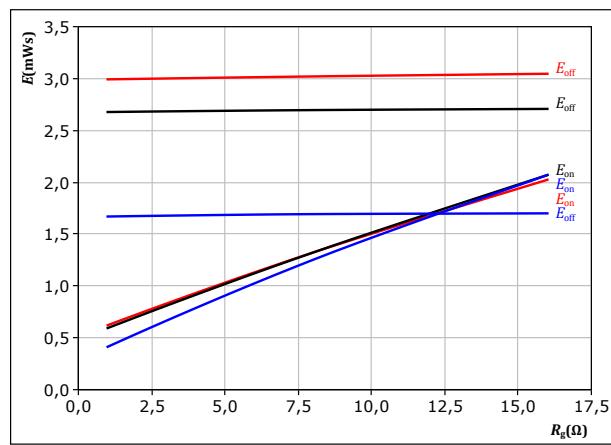
With an inductive load at

$V_{CE} = 600$ V $T_f:$ 25 °C
 $V_{GE} = \pm 15$ V 125 °C
 $R_{gon} = 4$ Ω 150 °C
 $R_{goff} = 4$ Ω

IGBT

figure 36.

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$



With an inductive load at

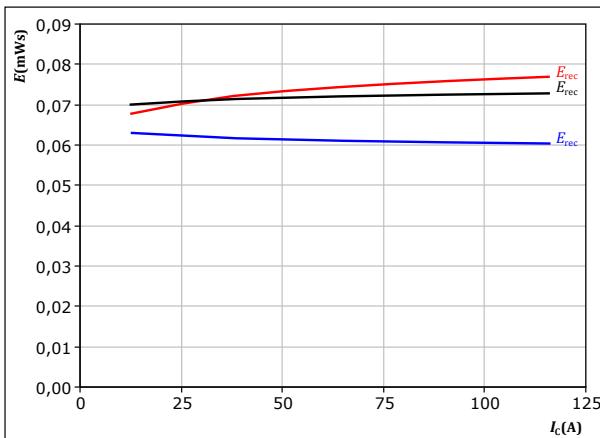
$V_{CE} = 600$ V $T_f:$ 25 °C
 $V_{GE} = \pm 15$ V 125 °C
 $I_c = 65$ A 150 °C

IGBT

figure 37.

Typical reverse recovered energy loss as a function of collector current

$E_{rec} = f(I_c)$



With an inductive load at

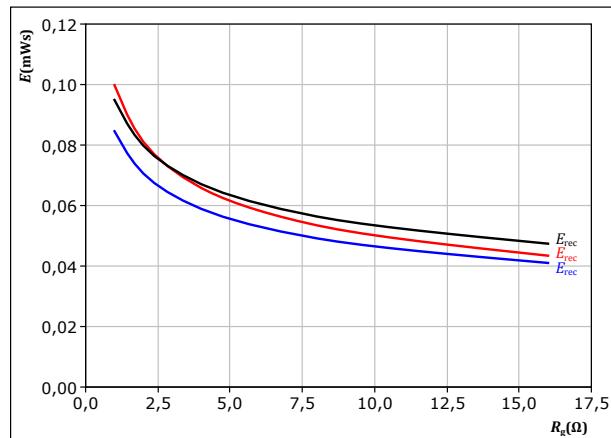
$V_{CE} = 600$ V $T_f:$ 25 °C
 $V_{GE} = \pm 15$ V 125 °C
 $R_{gon} = 4$ Ω

FWD

figure 38.

Typical reverse recovered energy loss as a function of gate resistor

$E_{rec} = f(R_g)$



With an inductive load at

$V_{CE} = 600$ V $T_f:$ 25 °C
 $V_{GE} = \pm 15$ V 125 °C
 $I_c = 65$ A 150 °C

FWD

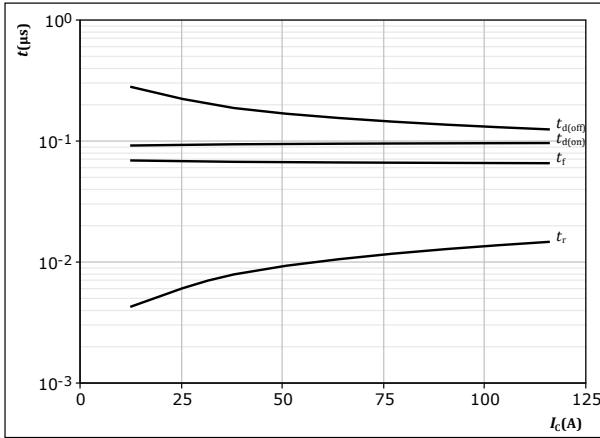


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Outer Boost Switching Characteristics

figure 39. IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$

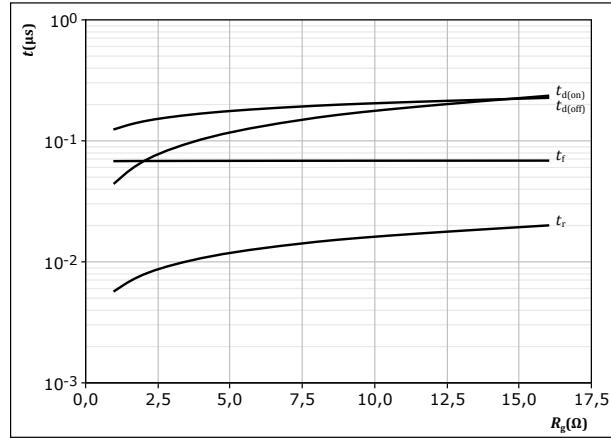


With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 4 \Omega$
 $R_{goff} = 4 \Omega$

figure 40. IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$

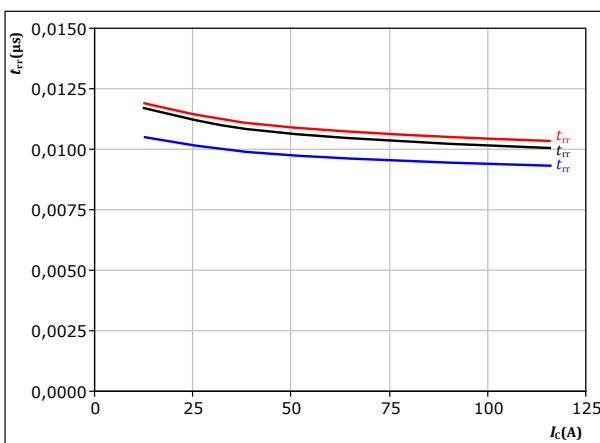


With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 65 \text{ A}$

figure 41. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$

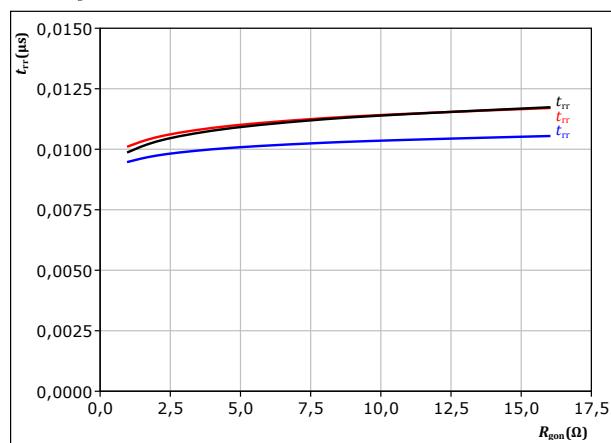


With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 4 \Omega$

figure 42. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 65 \text{ A}$



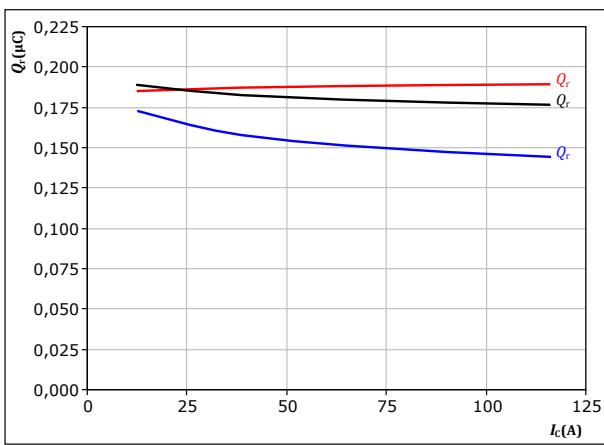
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Outer Boost Switching Characteristics

figure 43.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

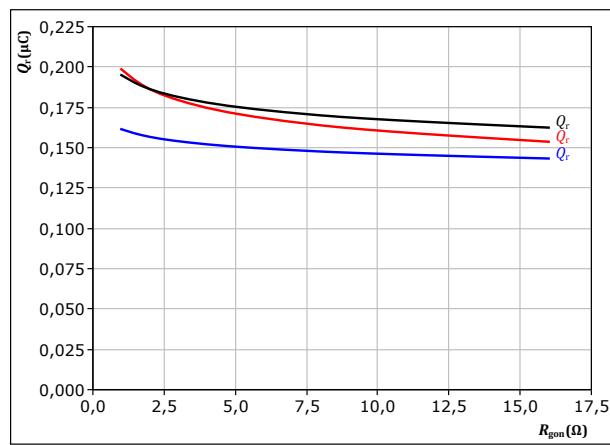
$$\begin{aligned} V_{CE} &= 600 \quad V \\ V_{GE} &= \pm 15 \quad V \\ R_{gon} &= 4 \quad \Omega \end{aligned} \quad T_f: \begin{array}{ll} \text{---} & 25 \text{ }^{\circ}\text{C} \\ \text{---} & 125 \text{ }^{\circ}\text{C} \\ \text{---} & 150 \text{ }^{\circ}\text{C} \end{array}$$

FWD

figure 44.

Typical recovered charge as a function of turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

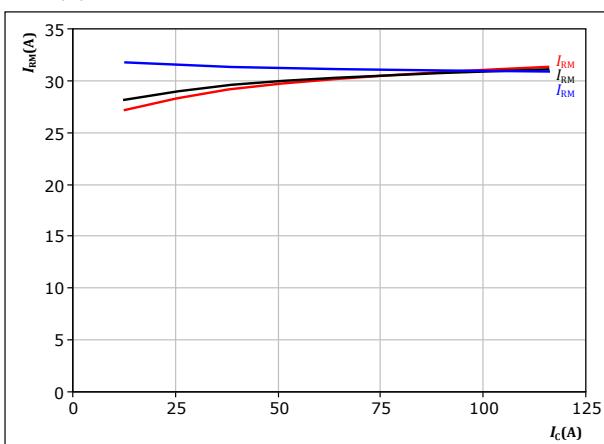
$$\begin{aligned} V_{CE} &= 600 \quad V \\ V_{GE} &= \pm 15 \quad V \\ I_c &= 65 \quad A \end{aligned} \quad T_f: \begin{array}{ll} \text{---} & 25 \text{ }^{\circ}\text{C} \\ \text{---} & 125 \text{ }^{\circ}\text{C} \\ \text{---} & 150 \text{ }^{\circ}\text{C} \end{array}$$

FWD

figure 45.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

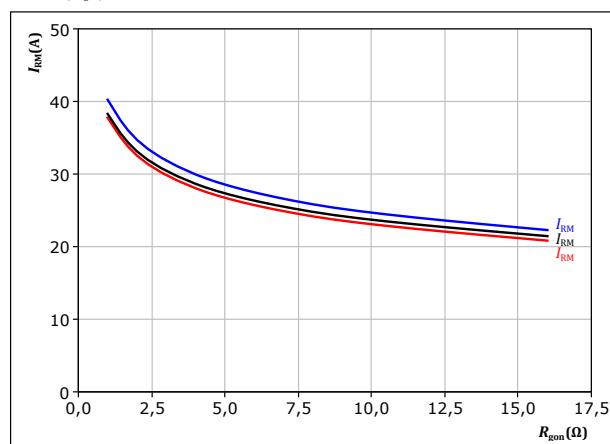
$$\begin{aligned} V_{CE} &= 600 \quad V \\ V_{GE} &= \pm 15 \quad V \\ R_{gon} &= 4 \quad \Omega \end{aligned} \quad T_f: \begin{array}{ll} \text{---} & 25 \text{ }^{\circ}\text{C} \\ \text{---} & 125 \text{ }^{\circ}\text{C} \\ \text{---} & 150 \text{ }^{\circ}\text{C} \end{array}$$

FWD

figure 46.

Typical peak reverse recovery current as a function of turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \quad V \\ V_{GE} &= \pm 15 \quad V \\ I_c &= 65 \quad A \end{aligned} \quad T_f: \begin{array}{ll} \text{---} & 25 \text{ }^{\circ}\text{C} \\ \text{---} & 125 \text{ }^{\circ}\text{C} \\ \text{---} & 150 \text{ }^{\circ}\text{C} \end{array}$$

FWD

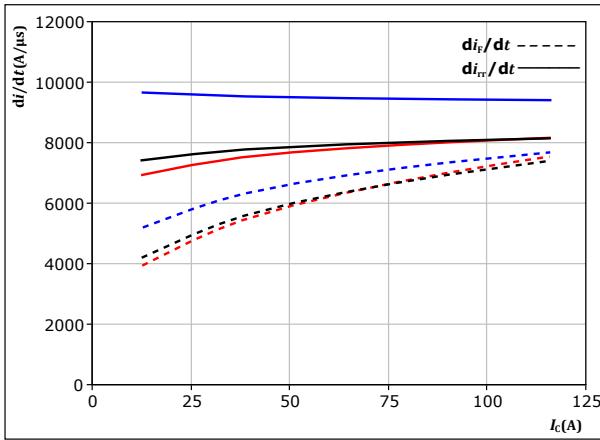


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Outer Boost Switching Characteristics

figure 47. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$

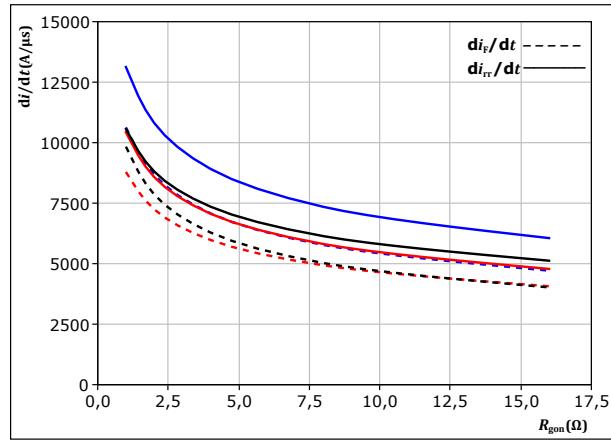


With an inductive load at

$V_{CE} = 600$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ\text{C}$
 $R_{gon} = 4$ Ω $T_j = 150^\circ\text{C}$

figure 48. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



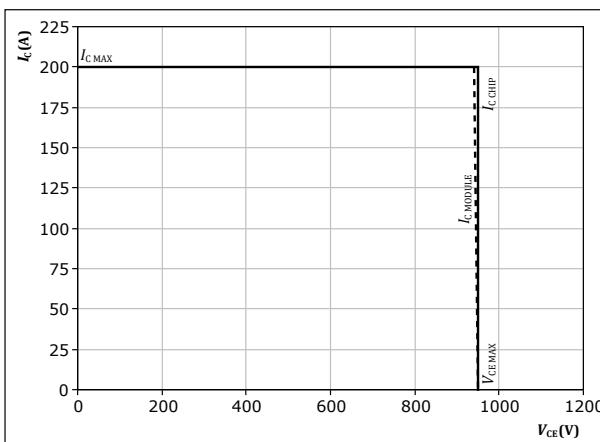
With an inductive load at

$V_{CE} = 600$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ\text{C}$
 $I_c = 65$ A $T_j = 150^\circ\text{C}$

figure 49. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At

$T_j = 150^\circ\text{C}$
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω



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Switching Definitions

figure 50. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

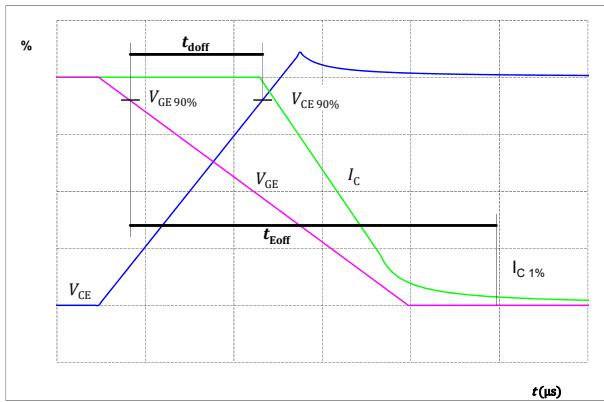


figure 51. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

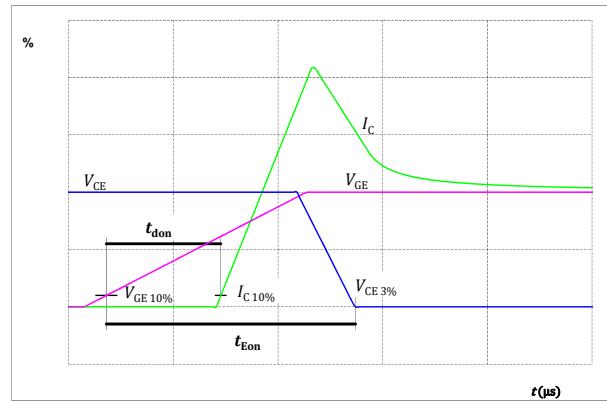


figure 52. IGBT

Turn-off Switching Waveforms & definition of t_f

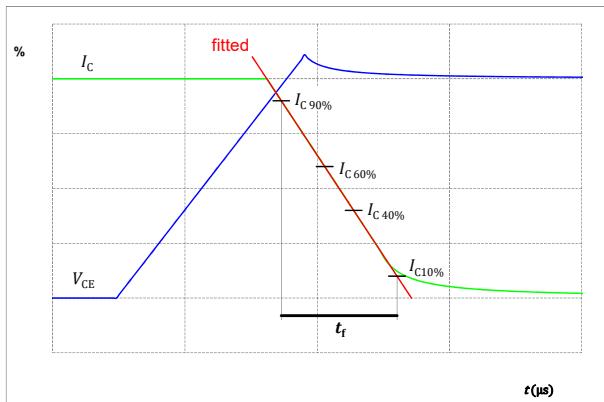
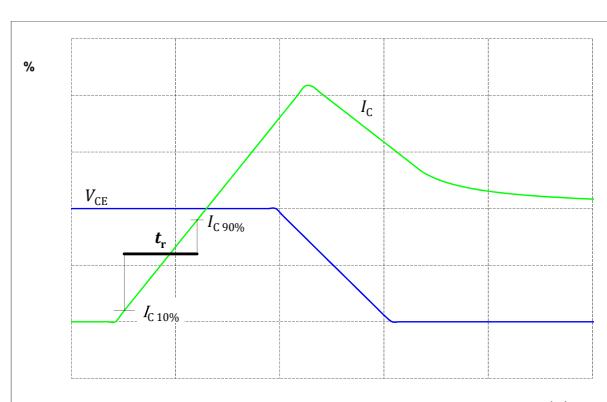


figure 53. IGBT

Turn-on Switching Waveforms & definition of t_r





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10-FY10B2A100S7-LP26L06

datasheet

Switching Definitions

figure 54.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

Turn-off Switching Waveforms & definition of t_{tr}

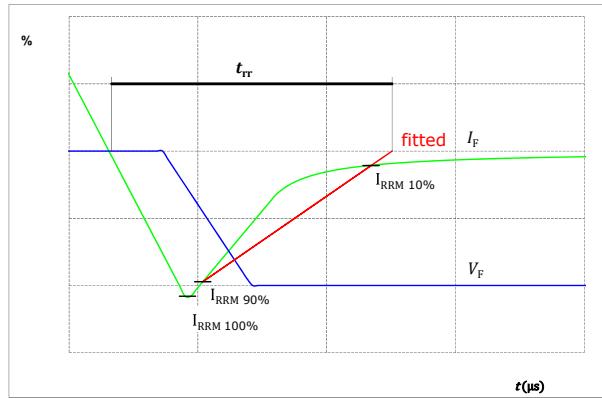
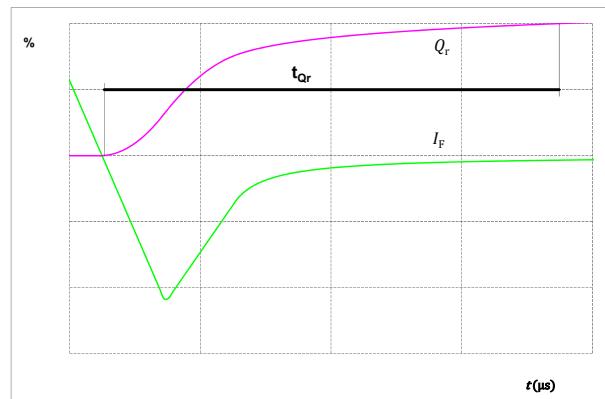


figure 55.

Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)

FWD

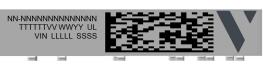
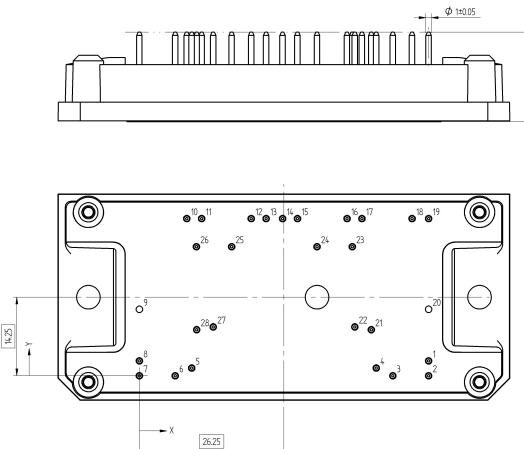
Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)



**10-FY10B2A100S7-LP26L06**

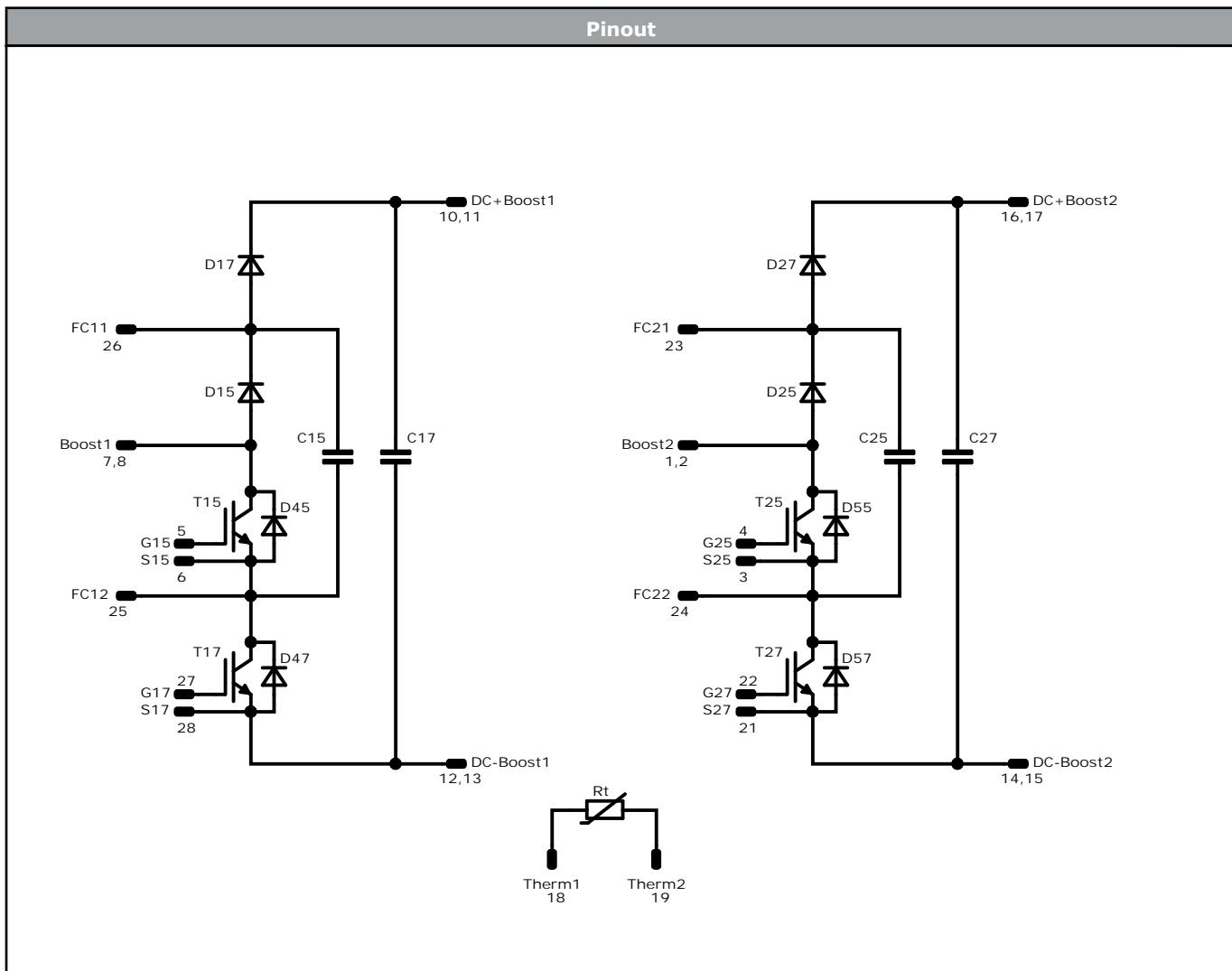
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Pin table [mm] <table border="1"><thead><tr><th>Pin</th><th>X</th><th>Y</th><th>Function</th></tr></thead><tbody><tr><td>1</td><td>52,5</td><td>2,7</td><td>Boost2</td></tr><tr><td>2</td><td>52,5</td><td>0</td><td>Boost2</td></tr><tr><td>3</td><td>46</td><td>0</td><td>S25</td></tr><tr><td>4</td><td>43</td><td>1,4</td><td>G25</td></tr><tr><td>5</td><td>9,5</td><td>1,4</td><td>G15</td></tr><tr><td>6</td><td>6,5</td><td>0</td><td>S15</td></tr><tr><td>7</td><td>0</td><td>0</td><td>Boost1</td></tr><tr><td>8</td><td>0</td><td>2,7</td><td>Boost1</td></tr><tr><td>9</td><td colspan="3">not assembled</td><td colspan="2"></td></tr><tr><td>10</td><td>8,6</td><td>28,5</td><td>DC+Boost1</td><td colspan="2"></td></tr><tr><td>11</td><td>11,3</td><td>28,5</td><td>DC+Boost1</td><td colspan="2"></td></tr><tr><td>12</td><td>20,3</td><td>28,5</td><td>DC- Boost1</td><td colspan="2"></td></tr><tr><td>13</td><td>23</td><td>28,5</td><td>DC- Boost1</td><td colspan="2"></td></tr><tr><td>14</td><td>26</td><td>28,5</td><td>DC- Boost2</td><td colspan="2"></td></tr><tr><td>15</td><td>28,7</td><td>28,5</td><td>DC- Boost2</td><td colspan="2"></td></tr><tr><td>16</td><td>37,7</td><td>28,5</td><td>DC+Boost2</td><td colspan="2"></td></tr><tr><td>17</td><td>40,4</td><td>28,5</td><td>DC+Boost2</td><td colspan="2"></td></tr><tr><td>18</td><td>49,5</td><td>28,5</td><td>Therm1</td><td colspan="2"></td></tr><tr><td>19</td><td>52,5</td><td>28,5</td><td>Therm2</td><td colspan="2"></td></tr><tr><td>20</td><td colspan="3">not assembled</td><td colspan="2"></td></tr><tr><td>21</td><td>42,1</td><td>8,35</td><td>S27</td><td colspan="2"></td></tr><tr><td>22</td><td>39,1</td><td>8,85</td><td>G27</td><td colspan="2"></td></tr><tr><td>23</td><td>38,65</td><td>23,4</td><td>FC21</td><td colspan="2"></td></tr><tr><td>24</td><td>32,25</td><td>23,4</td><td>FC22</td><td colspan="2"></td></tr><tr><td>25</td><td>16,75</td><td>23,4</td><td>FC12</td><td colspan="2"></td></tr><tr><td>26</td><td>10,35</td><td>23,4</td><td>FC11</td><td colspan="2"></td></tr><tr><td>27</td><td>13,4</td><td>8,85</td><td>G17</td><td colspan="2"></td></tr><tr><td>28</td><td>10,4</td><td>8,35</td><td>S17</td><td colspan="2"></td></tr></tbody></table>	Pin	X	Y	Function	1	52,5	2,7	Boost2	2	52,5	0	Boost2	3	46	0	S25	4	43	1,4	G25	5	9,5	1,4	G15	6	6,5	0	S15	7	0	0	Boost1	8	0	2,7	Boost1	9	not assembled					10	8,6	28,5	DC+Boost1			11	11,3	28,5	DC+Boost1			12	20,3	28,5	DC- Boost1			13	23	28,5	DC- Boost1			14	26	28,5	DC- Boost2			15	28,7	28,5	DC- Boost2			16	37,7	28,5	DC+Boost2			17	40,4	28,5	DC+Boost2			18	49,5	28,5	Therm1			19	52,5	28,5	Therm2			20	not assembled					21	42,1	8,35	S27			22	39,1	8,85	G27			23	38,65	23,4	FC21			24	32,25	23,4	FC22			25	16,75	23,4	FC12			26	10,35	23,4	FC11			27	13,4	8,85	G17			28	10,4	8,35	S17			 <p>Tolerance of pin positions: ±0.5mm at the end of pins. Dimension of coordinate axis is only offset without tolerance.</p>	
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Vincotech



Identification

ID	Component	Voltage	Current	Function	Comment
T15, T25	IGBT	950 V	100 A	Inner Boost Switch	
T17, T27	IGBT	950 V	100 A	Outer Boost Switch	
D15, D25	FWD	1200 V	30 A	Inner Boost Diode	
D17, D27	FWD	1200 V	30 A	Outer Boost Diode	
D45, D55	FWD	1200 V	35 A	Inner Boost Sw. Protection Diode	
D47, D57	FWD	1200 V	35 A	Outer Boost Sw. Protection Diode	
C15, C25	Capacitor	1000 V		Flying Capacitor	
C17, C27	Capacitor	1500 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	

**10-FY10B2A100S7-LP26L06**

datasheet

Vincotech**Packaging instruction**

Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample
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Handling instruction

Handling instructions for flow 1 packages see vincotech.com website.

Package data

Package data for flow 1 packages see vincotech.com website.

Vincotech thermistor reference

See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-FY10B2A100S7-LP26L06-D1-14	11 Nov. 2020		

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